TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74VHC245F, TC74VHC245FK

#### Octal Bus Transceiver

'OSHIBA

The TC74VHC245 is an advanced high speed CMOS OCTAL BUS TRANSCEIVER fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

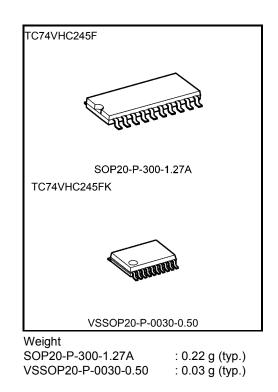
It is intended for two-way asynchronous communication between data busses. The direction of data transmission is determined by the level of the DIR input.

The enable input (  $\overline{\rm G}$  ) can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge.

#### Features (Note 1) (Note 2) (Note 3)

- High speed:  $t_{pd} = 4.0$  ns (typ.) at VCC = 5 V
- Low power dissipation:  $I_{CC} = 4 \mu A (max)$  at  $Ta = 25^{\circ}C$
- High noise immunity:  $V_{\text{NIH}} = V_{\text{NIL}} = 28\% V_{\text{CC}}$  (min)
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V<sub>CC</sub> (opr) = 2 V to 5.5 V
- Low noise: VOLP = 1.0 V (max)
- Pin and function compatible with 74ALS245



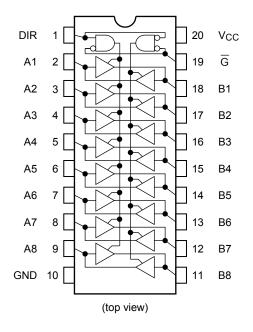
- Note 1: Do not apply a signal to any bus terminal when it is in the output mode. Damage may result.
- Note 2: All floating (high impedance) bus terminals must have their input levels fixed by means of pull up or pull down resistors.
- Note 3: A parasitic diode is formed between the bus and VCC terminals. Therefore bus terminal can not be used to interface 5 V to 3 V systems directly.

Start of commercial production 1991-05

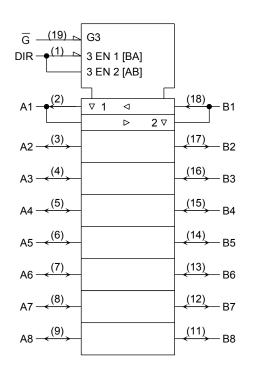
Downloaded From Oneyac.com

# TOSHIBA

#### **Pin Assignment**



#### **IEC Logic Symbol**



## **Truth Table**

| Inputs |     | Fun          | Output |        |  |
|--------|-----|--------------|--------|--------|--|
| G      | DIR | A Bus        | B Bus  | Output |  |
| L      | L   | Output       | Input  | A = B  |  |
| L      | Н   | Input Output |        | B = A  |  |
| Н      | Х   | 2            | Z      |        |  |

X: Don't care

Z: High impedance

## **Absolute Maximum Ratings (Note)**

| Characteristics                         | Symbol           | Rating                        | Unit |
|---|------------------|-------------------------------|------|
| Supply voltage range                    | V <sub>CC</sub>  | -0.5 to 7.0                   | V    |
| DC input voltage (DIR, $\overline{G}$ ) | VIN              | -0.5 to 7.0                   | V    |
| DC bus I/O voltage                      | V <sub>I/O</sub> | -0.5 to V <sub>CC</sub> + 0.5 | V    |
| Input diode current                     | lik              | -20                           | mA   |
| Output diode current                    | lok              | ±20                           | mA   |
| DC output current                       | lout             | ±25                           | mA   |
| DC V <sub>CC</sub> /ground current      | Icc              | ±75                           | mA   |
| Power dissipation                       | PD               | 180                           | mW   |
| Storage temperature                     | T <sub>stg</sub> | -65 to 150                    | °C   |

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Operating Ranges (Note)**

| Characteristics          | Symbol | Rating  | Unit |
|--------------------------|--------|---|------|
| Supply voltage           | Vcc    | 2.0 to 5.5  | V    |
| Input voltage (DIR, G)   | VIN    | 0 to 5.5  | V    |
| Bus I/O voltage          | Vi/o   | 0 to Vcc  | V    |
| Operating temperature    | Topr   | -40 to 85   | °C   |
| Input rise and fall time | dt/dv  | 0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V)<br>0 to 20 (V <sub>CC</sub> = 5 ± 0.5 V) | ns/V |

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either VCC or GND. Please connect both bus inputs and the bus outputs with VCC or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

## **Electrical Characteristics**

#### **DC Characteristics**

| Characteristics                      | Symbol          | Test Condition  |                          |            | Ta = 25°C    |     |                          | Ta =<br>−40 to 85°C |                          | Unit |
|--------------------------------------|-----------------|---|--------------------------|------------|--------------|-----|--------------------------|---------------------|--------------------------|------|
|                                      |                 |   | V <sub>CC</sub> (V)      | Min        | Тур.         | Max | Min                      | Max                 |                          |      |
| High-level input                     | Vih             | —   |                          | 2.0        | 1.50         |     | _                        | 1.50                | _                        | V    |
| voltage                              |                 |   |                          | 3.0 to 5.5 | Vcc ×<br>0.7 | _   | —                        | Vcc ×<br>0.7        | —                        |      |
| Low-level input                      |                 | _   |                          | 2.0        | _            |     | 0.50                     | _                   | 0.50                     |      |
| voltage                              | VIL             |   |                          | 3.0 to 5.5 | —            | —   | V <sub>CC</sub> ×<br>0.3 | —                   | V <sub>CC</sub> ×<br>0.3 | V    |
|                                      | V <sub>ОН</sub> | VIN<br>= VIH or VIL   |                          | 2.0        | 1.9          | 2.0 | _                        | 1.9                 | _                        |      |
|                                      |                 |   | I <sub>OH</sub> = −50 µA | 3.0        | 2.9          | 3.0 | —                        | 2.9                 | —                        |      |
| High-level output voltage            |                 |   |                          | 4.5        | 4.4          | 4.5 | —                        | 4.4                 | —                        | V    |
| voltage                              |                 |   | I <sub>OH</sub> = −4 mA  | 3.0        | 2.58         | _   | _                        | 2.48                | _                        |      |
|                                      |                 |   | I <sub>OH</sub> = −8 mA  | 4.5        | 3.94         | —   | —                        | 3.80                | —                        |      |
|                                      | Vol             | VIN<br>= VIH or VIL   |                          | 2.0        | _            | 0.0 | 0.1                      | _                   | 0.1                      |      |
|                                      |                 |   | I <sub>OL</sub> = 50 μA  | 3.0        | —            | 0.0 | 0.1                      | _                   | 0.1                      |      |
| Low-level output voltage             |                 |   |                          | 4.5        | —            | 0.0 | 0.1                      |                     | 0.1                      | V    |
| voltage                              |                 |   | I <sub>OL</sub> = 4 mA   | 3.0        | _            | _   | 0.36                     | _                   | 0.44                     |      |
|                                      |                 |   | I <sub>OL</sub> = 8 mA   | 4.5        | —            | —   | 0.36                     | —                   | 0.44                     |      |
| 3-state output off-<br>state current | I <sub>OZ</sub> | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>V <sub>OUT</sub> = V <sub>CC</sub> or GND |                          | 5.5        | _            | _   | ±0.25                    | _                   | ±2.50                    | μA   |
| Input leakage current                | lın             | V <sub>IN</sub> = 5.5 V or GND  |                          | 0 to 5.5   | _            | _   | ±0.1                     | _                   | ±1.0                     | μA   |
| Quiescent supply current             | Icc             | V <sub>IN</sub> = V <sub>CC</sub> or GND  |                          | 5.5        | _            | _   | 4.0                      | _                   | 40.0                     | μA   |

#### AC Characteristics (input: tr = tf = 3 ns)

| Characteristics               | Symbol                                 | Test Condition        |                     | Ta = 25°C           |     |      | Ta = −40 to<br>85°C |     | Unit |      |
|-------------------------------|--|-----------------------|---------------------|---------------------|-----|------|---------------------|-----|------|------|
| Characteriotics               | Cymbol                                 |                       | V <sub>CC</sub> (V) | C <sub>L</sub> (pF) | Min | Тур. | Max                 | Min | Max  | Onic |
|                               |  | _                     | 3.3 ± 0.3           | 15                  | _   | 5.8  | 8.4                 | 1.0 | 10.0 |      |
| Propagation delay             | t <sub>pLH</sub>                       |                       | $3.3 \pm 0.3$       | 50                  | _   | 8.3  | 11.9                | 1.0 | 13.5 | ns   |
| time                          | t <sub>pHL</sub>                       |                       | 50.05               | 15                  | _   | 4.0  | 5.5                 | 1.0 | 6.5  |      |
|                               |  |                       | 5.0 ± 0.5           | 50                  | _   | 5.5  | 7.5                 | 1.0 | 8.5  |      |
|                               | tpZL<br>tpZH                           | R <sub>L</sub> = 1 kΩ | 3.3 ± 0.3           | 15                  | _   | 8.5  | 13.2                | 1.0 | 15.5 |      |
| 3-state output enable         |  |                       | 3.3 ± 0.3           | 50                  | _   | 11.0 | 16.7                | 1.0 | 19.0 | ns   |
| time                          |  |                       | 5.0 ± 0.5           | 15                  | _   | 5.8  | 8.5                 | 1.0 | 10.0 |      |
|                               |  |                       |                     | 50                  | _   | 7.3  | 10.6                | 1.0 | 12.0 |      |
| 3-state output disable        | tpLZ<br>tpHZ                           | RL = 1 kΩ             | $3.3 \pm 0.3$       | 50                  | _   | 11.5 | 15.8                | 1.0 | 18.0 | 20   |
| time                          |  |                       | 5.0 ± 0.5           | 50                  | _   | 7.0  | 9.7                 | 1.0 | 11.0 | ns   |
| Output to output skew         | t <sub>osLH</sub><br>t <sub>osHL</sub> | (Nata 1)              | 3.3 ± 0.3           | 50                  | _   | _    | 1.5                 | -   | 1.5  |      |
| Output to output skew         |  | (Note 1)              | 5.0 ± 0.5           | 50                  | _   | _    | 1.0                 | -   | 1.0  | ns   |
| Input capacitance             | CIN                                    | DIR, G                |                     |                     | _   | 4    | 10                  | _   | 10   | pF   |
| Bus input capacitance         | CI/O                                   | An, Bn                |                     |                     | _   | 8    | _                   | _   | _    | pF   |
| Power dissipation capacitance | Cpd                                    |                       |                     | (Note 2)            | _   | 21   |                     |     |      | pF   |

Note 1: Parameter guaranteed by design.

tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|

Note 2: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

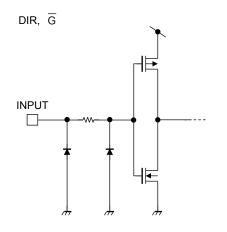
ICC (opr) = CPD·VCC·fIN + ICC / 8 (per bit)

#### Noise Characteristics (input: tr = tf = 3 ns) (Note)

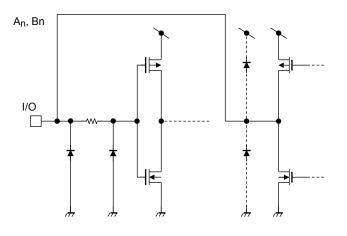
| Characteristics                                 | Querra ha a l    | Test Condition         | Ta =    |      | 25°C | 1.1  |
|---|------------------|------------------------|---------|------|------|------|
| Characteristics                                 | Symbol           |                        | Vcc (V) | Тур. | Max  | Unit |
| Quiet output maximum dynamic<br>V <sub>OL</sub> | V <sub>OLP</sub> | C <sub>L</sub> = 50 pF | 5.0     | 0.7  | 1.0  | V    |
| Quiet output minimum dynamic<br>V <sub>OL</sub> | V <sub>OLV</sub> | C <sub>L</sub> = 50 pF | 5.0     | -0.7 | -1.0 | V    |
| Minimum high level dynamic input voltage        | VIHD             | C <sub>L</sub> = 50 pF | 5.0     | _    | 3.5  | V    |
| Maximum low level dynamic input voltage         | V <sub>ILD</sub> | C <sub>L</sub> = 50 pF | 5.0     | _    | 1.5  | V    |

# TOSHIBA

## Input Equivalent Circuit



**Bus Terminal Equivalent Circuit** 

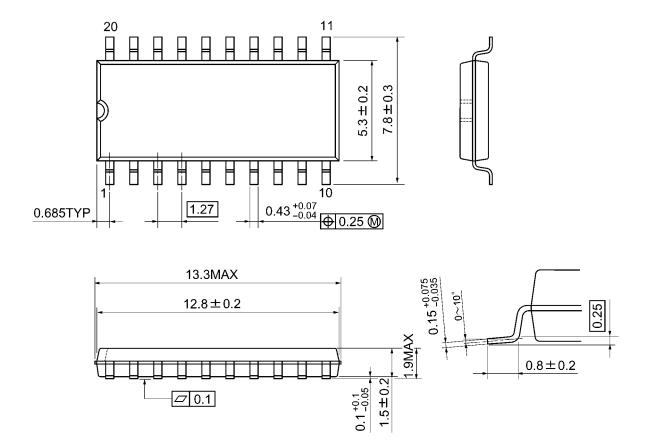




#### **Package Dimensions**

SOP20-P-300-1.27A

Unit: mm



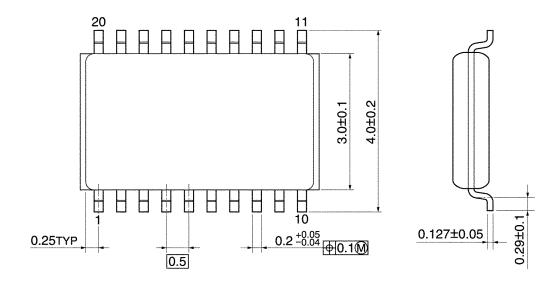
Weight: 0.22 g (typ.)

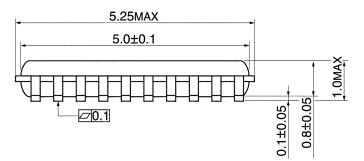


#### **Package Dimensions**

VSSOP20-P-0030-0.50

Unit: mm





Weight: 0.03 g (typ.)

## **RESTRICTIONS ON PRODUCT USE**

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, and devices related to power plant. IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your TOSHIBA sales representative or contact us via our website.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please
  use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including
  without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT
  OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

## **TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION**

https://toshiba.semicon-storage.com/

单击下面可查看定价,库存,交付和生命周期等信息

>>Toshiba(东芝)